SiP32411



Vishay Siliconix

2 A, 1.2 V, Slew Rate Controlled Load Switch

DESCRIPTION

The SiP32411 is a slew rate controlled load switch that is designed for 1.1 V to 5.5 V operation.

The device guarantees low switch on-resistance at 1.2 V input. It features a controlled soft-on slew rate of typical 150 µs that limits the inrush current for designs of capacitive load or noise sensitive loads.

The device features a low voltage control logic interface (on/off interface) that can interface with low voltage digital control without extra level shifting circuit. It also integrates an output discharge switch that enables fast shutdown load discharge. When the switch is off, it provides the reverse blocking to prevent high current flowing into the power source.

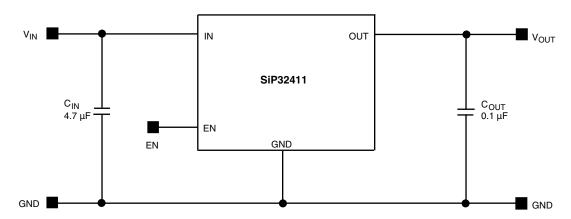
The SiP32411DN is in TDFN4 package of 1.2 mm by 1.6 mm. It supports over 2 A of continuous current. The SiP32411DR is in SC-70-6 package.

FEATURES

- 1.1 V to 5.5 V operation voltage range
- 62 m Ω typical from 2 V to 5 V for SiP32411DN
- 101 m Ω typical from 2 V to 5 V for SiP32411DR
- Low R_{ON} down to 1.2 V
- Slew rate controlled turn-on: 150 µs at 3.6 V
- Fast shutdown load discharge
- Low quiescent current
 < 1 μA when disabled
 6.7 μA at V_{IN} = 1.2 V
- Switch off reversed blocking
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Cellular phones
- · Portable media players
- Digital camera
- GPS
- Computers
- · Portable instruments and healthcare devices



TYPICAL APPLICATION CIRCUIT



ORDERING INFORMATION						
TEMPERATURE RANGE PACKAGE MARKING PART NUMBER						
-40 °C to 85 °C	SC-70-6	MBxx	SiP32411DR-T1-GE3			
-40 0 10 85 0	TDFN4 1.2 mm x 1.6 mm	Ex	SiP32411DNP-T1-GE4			

Notes

x = lot code

• -GE3 and -GE4 denotes halogen-free and RoHS-compliant

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Pb-free

RoHS

COMPLIANT

HALOGEN

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ABSOLUTE MAXIMUM RATINGS	6		
PARAMETER		LIMIT	UNIT
Supply input voltage (VIN)		-0.3 to 6	
Enable input voltage (V _{EN})		-0.3 to 6	V
Output voltage (V _{OUT})		-0.3 to V _{IN} +0.3	
Maximum continuous switch current (I _{max})	SC-70-6 package	1.8	
Maximum continuous switch current (I _{max.)}	TDFN4 1.2 mm x 1.6 mm	2.4	A
Maximum pulsed current (I _{DM}) V _{IN}	SC-70-6 package	2.2	
(pulsed at 1 ms, 10 % duty cycle)	TDFN4 1.2 mm x 1.6 mm	3	
ESD rating (HBM)		4000	V
Junction temperature (T _J)		-40 to +125	°C
Thermal tesistenes $(0, \cdot)$ a	6 pin SC-70-6 ^b	240	°C/W
Thermal tesistance (θ_{JA}) ^a	4 pin TDFN4 1.2 mm x 1.6 mm ^c	170	C/W
Device disciplation (D.) a	6 pin SC-70- 6 ^b	230	
Power dissipation (P _D) ^a	4 pin TDFN4 1.2 mm x 1.6 mm ^c	324	— mW

Notes

a. Device mounted with all leads and power pad soldered or welded to PC board, see PCB layout

b. Derate 4.5 mW/°C above $T_A = 70$ °C, see PCB layout

c. Derate 5.9 mW/°C above $T_A = 70$ °C, see PCB layout

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating/conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING RANGE				
PARAMETER	LIMIT	UNIT		
Input voltage range (V _{IN})	1.1 to 5.5	V		
Operating temperature range	-40 to 85	°C		



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SPECIFICATIONS							
PARAMETER	SYMBOL		TEST CONDITIONS UNLESS SPECIFIED $V_{IN} = 5$, $T_A = -40 \degree C$ to 85 $\degree C$		LIMITS -40 °C TO 85 °C		
			vpical values are at $T_A = 25 \text{ °C}$)	MIN. ^a	TYP. ^b	MAX. a	
Operating voltage ^c	V _{IN}			1.5	-	5.5	V
			V _{IN} = 1.2 V, EN = active	-	6.7	14	
			V _{IN} = 1.8 V, EN = active	-	14	24	
Quiescent current			$V_{IN} = 2.5 V, EN = active$		25	40	40
	Ι _Q		V _{IN} = 3.6 V, EN = active	-	40	60	
			$V_{IN} = 4.3 V$, EN = active	- 52 75 μA	μA		
			$V_{IN} = 5 V, EN = active$	-	71	99	
Off supply current	I _{Q(off)}		EN = inactive, OUT = open	-	-	1	
Off switch current	I _{DS(off)}		EN = inactive, OUT = GND	-	-	1	
Reverse blocking current	I _{RB}	V _{OUT}	= 5 V, V_{IN} = 1.2 V, V_{EN} = inactive	-	-	10	
			$V_{IN} = 1.2 \text{ V}, I_L = 100 \text{ mA}, T_A = 25 ^\circ\text{C}$	-	105	125	
			V_{IN} = 1.8 V, I_L = 100 mA, T_A = 25 °C	-	101	120	
		SC-70-6	$V_{IN} = 2.5 \text{ V}, I_L = 100 \text{ mA}, T_A = 25 ^\circ\text{C}$	-	101	120	
		00 10 0	$V_{IN} = 3.6 \text{ V}, I_L = 100 \text{ mA}, T_A = 25 ^\circ\text{C}$	-	101	120	
			V_{IN} = 4.3 V, I_L = 100 mA, T_A = 25 °C	-	101	120	
On-resistance	R _{DS(on)}		$V_{IN} = 5 \text{ V}, \text{ I}_{L} = 100 \text{ mA}, \text{ T}_{A} = 25 ^{\circ}\text{C}$	-	101	120	mΩ 2 2
	1 1DS(01)	TDFN4 1.2 mm	$V_{IN} = 1.2 \text{ V}, I_L = 100 \text{ mA}, T_A = 25 ^{\circ}\text{C}$	-	66	76	
			$V_{IN} = 1.8 \text{ V}, I_L = 100 \text{ mA}, T_A = 25 ^{\circ}\text{C}$	-	62	72	
			$V_{IN} = 2.5 \text{ V}, I_L = 100 \text{ mA}, T_A = 25 ^{\circ}\text{C}$	-	62	72	
		x 1.6 mm	$V_{IN} = 3.6 \text{ V}, I_L = 100 \text{ mA}, T_A = 25 \text{ °C}$	-	62	72	
			$V_{IN} = 4.3 \text{ V}, \text{ I}_{L} = 100 \text{ mA}, \text{ T}_{A} = 25 ^{\circ}\text{C}$	C - 62 72			
			$V_{IN} = 5 \text{ V}, \text{ I}_{L} = 100 \text{ mA}, \text{ T}_{A} = 25 ^{\circ}\text{C}$	-	62	72	
On-resistance temperature	TC _{RDS}		SC-70-6 package	-	4300	-	ppm/°C
coefficient	103	TDI	FN4 1.2 mm x 1.6 mm package	-	3400	-	1919-11-0 - E
			V _{IN} = 1.2 V	-	-	0.3	_
			V _{IN} = 1.8 V	-	-	0.4 ^d	
EN input low voltage c	VIL		V _{IN} = 2.5 V	-	-	0.5 ^d	
	12		V _{IN} = 3.6 V	-	-	0.6 ^d	
			V _{IN} = 4.3 V	-	-	0.7 ^d	
			V _{IN} = 5 V		-	0.8 ^d	v
			V _{IN} = 1.2 V	0.9 ^d	-	-	
		-	V _{IN} = 1.8 V	1.2 ^d	-	-	-
EN input high voltage ^c	V _{IH}		V _{IN} = 2.5 V	1.4 ^d	-	-	-
putgit totage			V _{IN} = 3.6 V	1.6 ^d	-	-	4
			$V_{IN} = 4.3 V$	1.7 d	-	-	-
			$V_{IN} = 5 V$	1.8	-	-	
EN Input leakage			$V_{\rm EN} = 5.5 \text{ V}$	-1	-	1	μΑ
Output pull-down resistance	R _{PD}		EN = inactive, T _A = 25 °C	-	217	280	Ω
Output turn-on delay time	t _{d(on)}			-	140	210	4
Output turn-on rise time	t _(on)	V _{IN} =	= 3.6 V, R_{load} = 10 Ω , T_A = 25 °C	80	150	220	μs
Output turn-off delay time	t _{d(off)}			-	0.27	1	

Notes

a. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum

b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing

c. For V_{IN} outside this range consult typical EN threshold curve

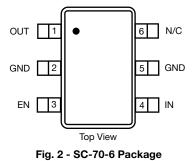
d. Not tested, guarantee by design

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PIN CONFIGURATION



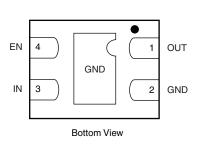


Fig. 3 - TDFN4 1.2 mm x 1.6 mm Package

PIN DE	PIN DESCRIPTION					
PIN NUMBER NAME		NAME	FUNCTION			
SC-70-6	TDFN4	NAME	FONCTION			
4	3	IN	This pin is the n-channel MOSFET drain connection. Bypass to ground through a 2.2 µF capacitor			
2, 5	2	GND	Ground connection			
3	4	EN	Enable input			
1	1	OUT	This pin is the n-channel MOSFET source connection. Bypass to ground through a 0.1 µF capacitor			

TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

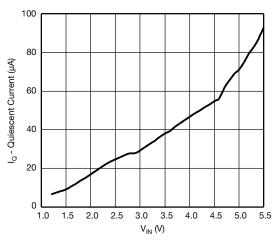


Fig. 4 - Quiescent Current vs. Input Voltage

V_{IN} (V)

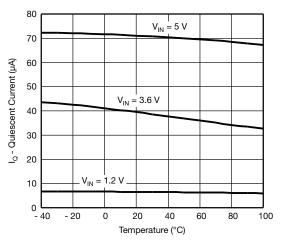
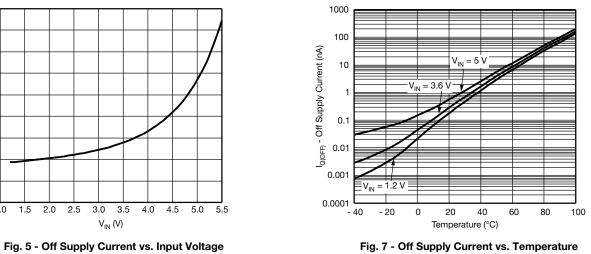


Fig. 6 - Quiescent Current vs. Temperature





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1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0

0.9

0.8

0.7

0.6

0.5

0.4

0.3

0.2

0.1

0 L 1.0

I_{Q(OFF)} - Off Supply Current (nA)

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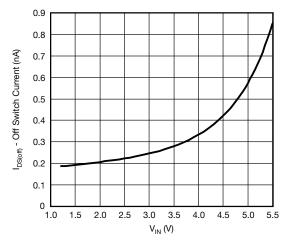


Fig. 8 - Off Switch Current vs. Input Voltage

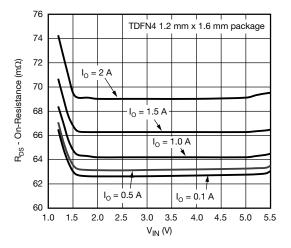


Fig. 9 - R_{DS(on)} vs. V_{IN} for TDFN4 package

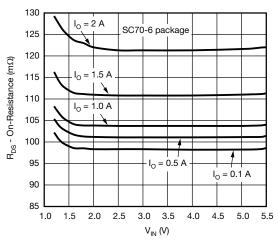


Fig. 10 - R_{DS(on)} vs. V_{IN} for SC-70-6 package

1000 100 I_{DS(off)} - Off Switch Current (nA) V_{IN} = 5 V 10 V_{IN} = 3.6 V 1 0.1 0.01 1.2 0.001 40 - 20 20 40 60 80 100 0 Temperature (°C)

Fig. 11 - Off Switch Current vs. Temperature

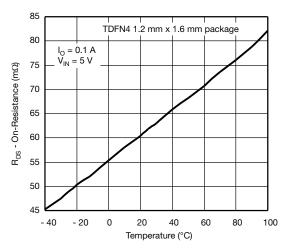


Fig. 12 - R_{DS(on}) vs. Temperature for TDFN4 package

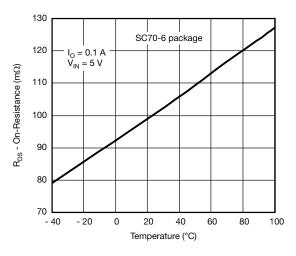


Fig. 13 - R_{DS(on)} vs. Temperature for SC-70-6 package

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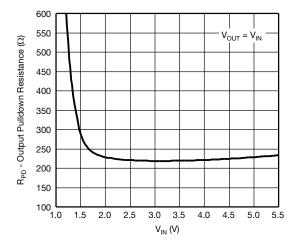


Fig. 14 - Output Pull Down vs. Input Voltage

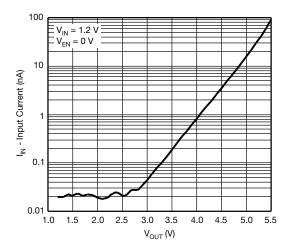


Fig. 15 - Reverse Blocking Current vs. Output Voltage

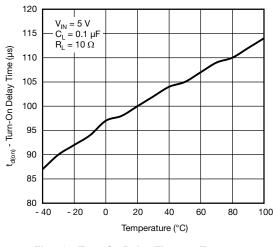


Fig. 16 - Turn-On Delay Time vs. Temperature

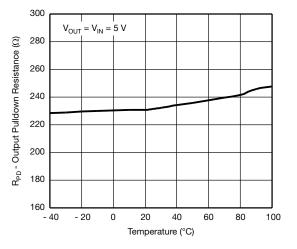


Fig. 17 - Output Pull Down vs. Temperature

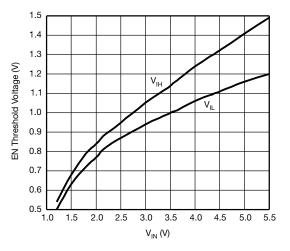


Fig. 18 - EN Threshold Voltage vs. Input Voltage

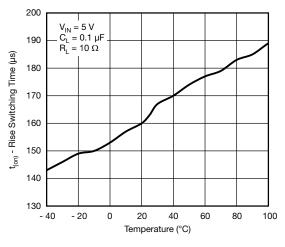


Fig. 19 - Rise Time vs. Temperature

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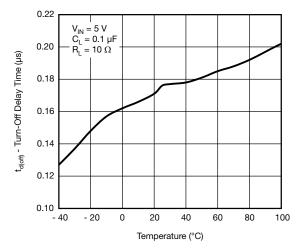
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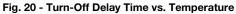
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TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)





TYPICAL WAVEFORMS

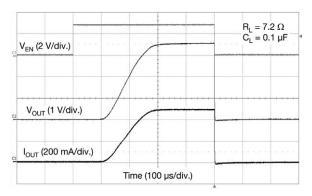
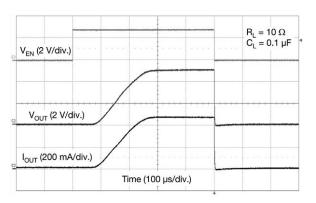


Fig. 21 - Switching (V_{IN} = 3.6 V)





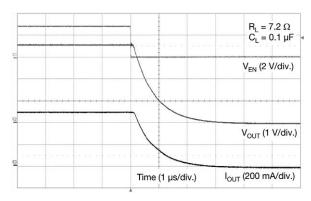


Fig. 23 - Turn-Off (V_{IN} = 3.6 V)

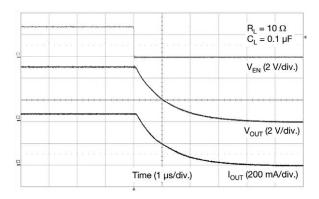


Fig. 24 - Turn-Off (V_{IN} = 5 V)

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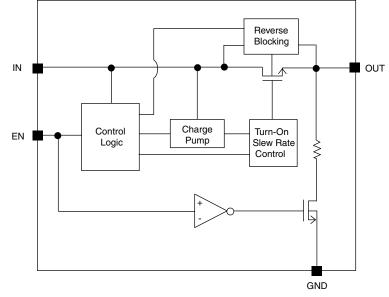
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BLOCK DIAGRAM





PCB LAYOUT

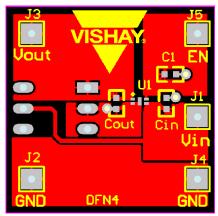


Fig. 26 - Top, PCB Layout for TDFN4 1.2 mm x 1.6 mm (board size: 1" x 1v)

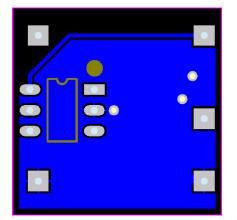


Fig. 27 - Bottom, PCB Layout for TDFN4 1.2 mm x 1.6 mm (board size: 1" x 1")

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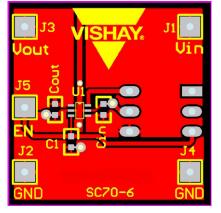


Fig. 28 - Top, PCB Layout for SC-70-6 (board size: 1" x 1")

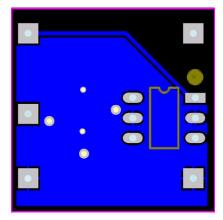


Fig. 29 - Bottom, PCB Layout for SC-70-6 (board size: 1" x 1")

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DETAILED DESCRIPTION

SiP32411 is an n-channel power MOSFET designed as high side load switch with slew rate control to prevent in-rush current. Once enable the device charge pumps the gate of the power MOSFET to 5 V gate to source voltage while controlling the slew rate of the turn on time. The mostly constant gate to source voltage keeps the on resistance low through out the input voltage range. When disable, the output discharge circuit turns on to help pull the output voltage to ground more quickly. Also in disable mode, the reverse blocking circuit is activated to prevent current from going back to the input in case the output voltage is higher than the input voltage. Input voltage is needed for the reverse blocking circuit to work properly, it can be as low as $V_{IN(min.)}$.

APPLICATION INFORMATION

Input Capacitor

While a bypass capacitor on the input is not required, a 2.2 μ F or larger capacitor for C_{IN} is recommended in almost all applications. The bypass capacitor should be placed as physically close as possible to the SiP32411 to be effective in minimizing transients on the input. Ceramic capacitors are recommended over tantalum because of their ability to withstand input current surges from low impedance sources such as batteries in portable devices.

Output Capacitor

A 0.1 μ F capacitor or larger across V_{OUT} and GND is recommended to insure proper slew operation. C_{OUT} may be increased without limit to accommodate any load transient condition with only minimal affect on the SiP32411 turn on slew rate time. There are no ESR or capacitor type requirement.

Enable

The EN pin is compatible with both TTL and CMOS logic voltage levels.

Protection Against Reverse Voltage Condition

The SiP32411 contains a reverse blocking circuitry to protect the current from going to the input from the output in case where the output voltage is higher than the input voltage when the main switch is off. A supply voltage as low as the minimum required input voltage is necessary for this circuitry to work properly.

Thermal Considerations

The SiP32411 is designed to maintain a constant output load current. Due to physical limitations of the layout and assembly of the device the maximum switch current is 1.8 A

for SC-70-6 package and 2.4 A for TDFN4 package, as stated in the absolute maximum ratings table. However, another limiting characteristic for the safe operating load current is the thermal power dissipation of the package. To obtain the highest power dissipation (and a thermal resistance of 240 °C/W for SC-70-6 and 170 °C/W for TDFN4) the power pad of the device should be connected to a heat sink on the printed circuit board.

The maximum power dissipation in any application is dependent on the maximum junction temperature, $T_{J(max.)} = 125$ °C, the junction-to-ambient thermal resistance for the TDFN4 1.2 mm x 1.6 mm package, $\theta_{J-A} = 170$ °C/W, and the ambient temperature, T_A , which may be formulaically expressed as:

P (max.) =
$$\frac{T_{J (max.)} - T_{A}}{\theta_{...A}} = \frac{125 - T_{A}}{170}$$

It then follows that, assuming an ambient temperature of 70 $^{\circ}$ C, the maximum power dissipation will be limited to about 324 mW.

So long as the load current is below the 2.4 A limit, the maximum continuous switch current becomes a function two things: the package power dissipation and the $R_{DS(on)}$ at the ambient temperature.

As an example let us calculate the worst case maximum load current at $T_A = 70$ °C. The worst case $R_{DS(on)}$ at 25 °C occurs at an input voltage of 1.2 V and is equal to 75 m Ω . The $R_{DS(on)}$ at 70 °C can be extrapolated from this data using the following formula

 $R_{DS(on)}$ (at 70 °C) = $R_{DS(on)}$ (at 25 °C) x (1 + $T_C x \Delta T$)

Where T_{C} is 3400 ppm/°C. Continuing with the calculation we have

 $\mathsf{R}_{\mathsf{DS(on)}}$ (at 70 °C) = 75 m Ω x (1 + 0.0034 x (70 °C - 25 °C)) = 86.5 m Ω

The maximum current limit is then determined by

$$I_{LOAD (max.)} < \sqrt{\frac{P (max.)}{R_{DS(on)}}}$$

which in case is 1.94 A. Under the stated input voltage condition, if the 1.94 A current limit is exceeded the internal die temperature will rise and eventually, possibly damage the device.



PRODUCT SUMMARY			
Part number	SiP32411	SiP32411	
Description	1.1 V to 5 V, 62 mΩ, 150 µs rise time, output discharge	1.1 V to 5 V, 101 m Ω , 150 μ s rise time output discharge	
Configuration	Single	Single	
Slew rate time (µs)	150	150	
On delay time (µs)	140	140	
Input voltage min. (V)	1.1	1.1	
Input voltage max. (V)	5.5	5.5	
On-resistance at input voltage min. (m Ω)	66	105	
On-resistance at input voltage max. (m Ω)	62	101	
Quiescent current at input voltage min. (µA)	6.7	6.7	
Quiescent current at input voltage max. (µA)	71	71	
Output discharge (yes / no)	Yes	Yes	
Reverse blocking (yes / no)	Yes	Yes	
Continuous current (A)	2.4	1.8	
Package type	TDFN4	SC-70-6	
Package size (W, L, H) (mm)	1.2 x 1.6 x 0.5	2.0 x 2.0 x 0.5	
Status code	2	2	
Product type	Slew rate	Slew rate	
Applications	Computers, consumer, industrial, healthcare, networking, portable	Computers, consumer, industrial, healthcare, networking, portable	

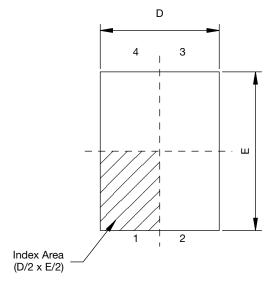
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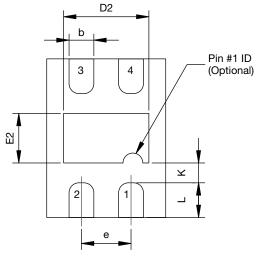
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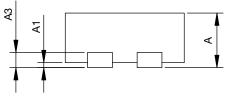
TDFN4 1.2 x 1.6 Case Outline



Top View



Bottom View



Side View

DIM.	DIM		MILLIMETERS			INCHES	
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.45	0.55	0.60	0.017	0.022	0.024	
A1	0.00	-	0.05	0.00	-	0.002	
A3	0.	15 REF. or 0.127 REF	. (1)		0.006 or 0.005 ⁽¹⁾		
b	0.20	0.25	0.30	0.008	0.010	0.012	
D	1.15	1.20	1.25	0.045	0.047	0.049	
D2	0.81	0.86	0.91	0.032	0.034	0.036	
е		0.50 BSC	•	0.020			
E	1.55	1.60	1.65	0.061	0.063	0.065	
E2	0.45	0.50	0.55	0.018	0.020	0.022	
К		0.25 typ.	•		0.010 typ.	•	
L	0.25	0.30	0.35	0.010	0.012	0.014	
L ECN: T16-0143-F DWG: 5995	0.25 Rev. C, 18-Apr-16	0.30	0.35	0.010	0.012		

Note

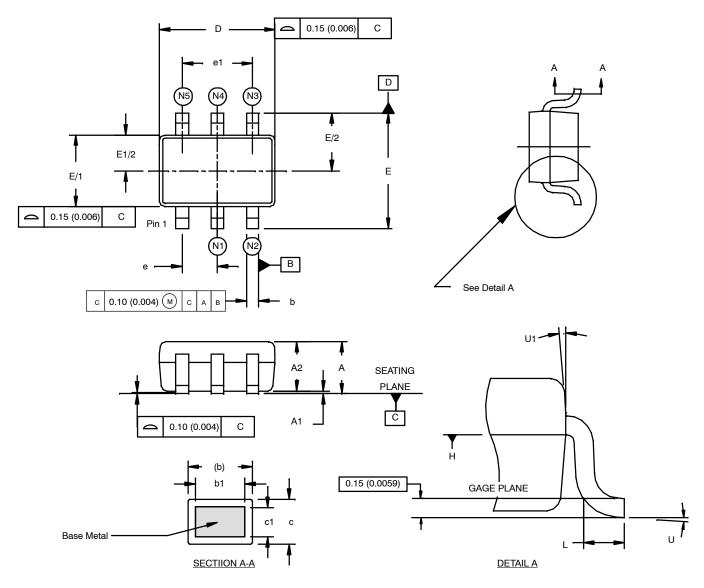
⁽¹⁾ The dimension depends on the leadframe that assembly house used.

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1



SC-70: 3/4/5/6-LEADS (PIC ONLY)



Pin	L	LEAD COUNT				
Code	3	4	5	6		
N1	-	-	2	2		
N2	2	2	3	3		
N3	-	3	4	4		
N4	3	-	-	5		
N5	-	4	5	6		

NOTES:

- 1. Dimensioning and tolerancing per ANSI Y14.5M-1994.
- 2. Controlling dimensions: millimeters converted to inch dimensions are not necessarily exact.
- Dimension "D" does not include mold flash, protrusion or gate burr. Mold flash, protrusion or gate burr shall not exceed 0.15 mm (0.006 inch) per side.
- 4. The package top shall be smaller than the package bottom. Dimension "D" and "E1" are determined at the outer most extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

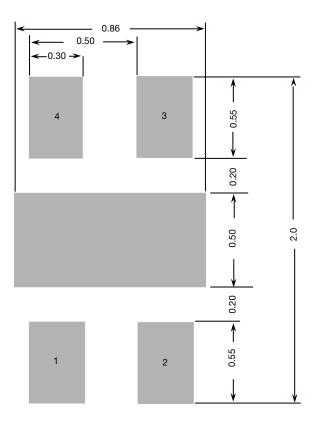
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	M	ILLIMETE	RS	INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.80	-	1.10	0.031	-	0.043
A1	0.00	-	0.10	0.000	-	0.004
A2	0.80	0.90	1.00	0.031	0.035	0.040
b	0.15	-	0.30	0.006	-	0.012
b1	0.15	0.20	0.25	0.006	0.008	0.010
C	0.08	-	0.25	0.003	-	0.010
c1	0.08	0.13	0.20	0.003	0.005	0.008
D	1.90	2.10	2.15	0.074	0.082	0.084
Е	2.00	2.10	2.20	0.078	0.082	0.086
E ₁	1.15	1.25	1.35	0.045	0.050	0.055
е		0.65 BSC	r		0.0255 BSC	1
e ₁		1.30 BSC			0.0512 BSC	
L	0.26	0.36	0.46	0.010	0.014	0.018
U	0°	-	8 °	0°	-	8°
U1	4°		10°	4°		10°



RECOMMENDED MINIMUM PADS FOR TDFN4 1.2 x 1.6



Recommended Minimum Pads Dimensions in mm

Document Number: 66558 Revision: 05-Mar-10



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